12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20250131002.2
Adding KL-PR & TIEM-PR as additional wafer probe site
Change Notification / Sample Request

Date: February 03, 2025
To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team
SC Business Services

20250131002.2
Change Notification / Sample Request
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records**,** you have recently purchased these devices**.** The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
UCC28C45QDRQ1	UCC28C45QDRQ1
UCC12041QDVERQ1	NULL
OPA4316QPWRQ1	NULL
TAS6422EQDKQRQ1	NULL
TPS929121QPWPRQ1	NULL
TPS929160QDCPRQ1	NULL
DRV3245BEPHPRQ1	DRV3245BEPHPRQ1
INA241A4QDGKRQ1	NULL
TMAG5170A2EDGKRQ1	NULL
INA241A5QDGKRQ1	NULL
TMAG5170A1EDGKRQ1	NULL
TPS92520QDAPRQ1	NULL
UCC28C51QDRQ1	NULL
LM2904VQPWRG4Q1	NULL
TPS62423QDRCRQ1	TPS62423QDRCRQ1
TPS62162QDSGRQ1	TPS62162QDSGRQ1
INA2181A1QDGSRQ1	INA2181A1QDGSRQ1
LM76202QPWPRQ1	LM76202QPWPRQ1
TAS6421QDKQRQ1	NULL
DRV8910QPWPRQ1	DRV8910QPWPRQ1
TAS6424QDKQRQ1	NULL
CC2642R1FTWRGZRQ1	NULL
TPS62172QDSGTQ1	TPS62172QDSGTQ1
INA240A2QPWRQ1	NULL
INA381A3QDGSRQ1	INA381A3QDGSRQ1
INA241A3QDGKRQ1	NULL
INA241B4QDGKRQ1	NULL
DRV8908QPWPRQ1	DRV8908QPWPRQ1
INA240A3QPWRQ1	NULL
INA241A2QDGKRQ1	NULL
INA241B3QDGKRQ1	NULL
LM74700QDRQ1	NULL
TAS6422QDKQQ1	NULL
UCC28C56LQDRQ1	NULL
INA241B2QDGKRQ1	NULL
TPS62424QDRCRQ1	TPS62424QDRCRQ1
INA381A2QDGSRQ1	INA381A2QDGSRQ1
DRV8912QPWPRQ1	DRV8912QPWPRQ1
TPS92519QDAPRQ1	NULL
UCC12051QDVERQ1	NULL
DS90UB954TRGZTQ1	NULL
INA2181A4QDGSRQ1	INA2181A4QDGSRQ1
UCC28730QDRQ1	NULL
AWR6843ABGABLQ1	AWR6843ABGABLQ1
TPS929121AQPWPRQ1	NULL
INA241B5QDGKRQ1	NULL
DS90UB936TRGZTQ1	NULL

TPS92663AQPWPRQ1	NULL
DS90UB953ATRHBTQ1	NULL
UCC28731QDRQ1	NULL
TLV4197QPWRQ1	NULL
TPS2HB50BQPWPRQ1	TPS2HB50BQPWPRQ1
DRV8906QPWPRQ1	DRV8906QPWPRQ1
LM2904QPWRG4Q1	NULL
TPS92520QDADRQ1	NULL
DRV3245BEPHPRQ1	595-DRV3245BEPHPRQ1
AM62A32ASMSIAMBRQ1	NULL
HDC3020QDEFRQ1	NULL
TLV4316QPWRQ1	NULL
DRV8243HQDGQRQ1	NULL
HDC3022QDEJRQ1	NULL
INA310B2QDGKRQ1	NULL
TPS929240QDCPRQ1	NULL
INA310B3QDGKRQ1	NULL
AWR6843ARBGALPQ1	NULL
TPS92662QPHPRQ1	NULL
DS90UB935TRHBTQ1	NULL
INA310B4QDGKRQ1	NULL
DS90UB953TRHBTQ1	NULL
TAS6424QDKQQ1	NULL
OPA4197QPWRQ1	NULL
DRV3245AEPHPRQ1	DRV3245AEPHPRQ1
LM2904BQPWRQ1	NULL
INA296A3QDGKRQ1	NULL
LM2904BTQPWRQ1	NULL
INA296A2QDGKRQ1	NULL
TPS92515QDGQRQ1	TPS92515QDGQRQ1
DRV8874QPWPRQ1	NULL
TPS2HB16FQPWPRQ1	NULL
UCC28740QDRQ1	UCC28740QDRQ1
INA240A4QPWRQ1	NULL
OPA4172AQPWRQ1	OPA4172AQPWRQ1
TPS929240AQDCPRQ1	NULL
TAS6424LQDKQRQ1	NULL
DS90UB638TRGZTQ1	NULL
TPS2HB50AQPWPRQ1	TPS2HB50AQPWPRQ1
TAS6424EQDKQRQ1	NULL
TAS6424MQDKQRQ1	NULL
TPS62172QDSGRQ1	TPS62172QDSGRQ1
TPS62407QDRCRQ1	595-TPS62407QDRCRQ1
DRV8243PQDGQRQ1	NULL
TAS6424MSQDKQRQ1	NULL
INA296A4QDGKRQ1	NULL
INA296A5QDGKRQ1	NULL
TPS92662QPHPTQ1	NULL
INA240A1QPWRQ1	NULL
TPS92664QPHPRQ1	NULL
UCC27712QDRQ1	UCC27712QDRQ1
TPS62162QDSGTQ1	TPS62162QDSGTQ1
DS90UB635TRHBTQ1	NULL
TPS62405QDRCRQ1	595-TPS62405QDRCRQ1
TPS62407QDRCRQ1	TPS62407QDRCRQ1
BQ79758QPAPRQ1	NULL
TPS62422QDRCRQ1	595-TPS62422QDRCRQ1
TPS92667QPHPRQ1	NULL

UCC28C43QDRQ1	UCC28C43QDRQ1
TPS62400QDRCRQ1	TPS62400QDRCRQ1
UCC28C57HQDRQ1	NULL
TPS92662AQPHPRQ1	NULL
DRV8244SQDGQRQ1	NULL
INA4180A1QPWRQ1	NULL
DRV8243SQDGQRQ1	NULL
DRV8143PQDGQRQ1	NULL
TPS2HB16AQPWPRQ1	TPS2HB16AQPWPRQ1
UCC28C55QDRQ1	NULL
DRV8904QPWPRQ1	DRV8904QPWPRQ1
TPS62422QDRCRQ1	TPS62422QDRCRQ1
TPS92515HVQDGQRQ1	TPS92515HVQDGQRQ1
DS90UB954TRGZRQ1	NULL
UCC28C57LQDRQ1	NULL
TPS2HB16BQPWPRQ1	TPS2HB16BQPWPRQ1
TPS62405QDRCRQ1	TPS62405QDRCRQ1
INA296B4QDGKRQ1	NULL
OPA4991TQPWRQ1	NULL
DRV8244PQDGQRQ1	NULL
INA296B5QDGKRQ1	NULL
TAS6424LQDKQQ1	NULL
UCC28C56HQDRQ1	NULL
LM74202QPWPRQ1	LM74202QPWPRQ1
LM2904VQPWRQ1	NULL
TPS92515QDGQTQ1	TPS92515QDGQTQ1
DRV8143HQDGQRQ1	NULL
DS90UB935TRHBRQ1	NULL
INA310A2QDGKRQ1	NULL
UCC28C40QDRQ1	NULL
DRV8244HQDGQRQ1	NULL
INA310A3QDGKRQ1	NULL
DS90UB953TRHBRQ1	NULL
INA310A4QDGKRQ1	NULL
UCC28C53QDRQ1	NULL
TPS62402QDRCRQ1	TPS62402QDRCRQ1
TPS92515HVQDGQTQ1	TPS92515HVQDGQTQ1
HDC3021QDEHRQ1	NULL
AM62A34ASMSIAMBRQ1	NULL
AM62A74AUMSIAMBRQ1	NULL
UCC28C50QDRQ1	NULL
TAS6424RQDKQRQ1	NULL
UCC27712QDQ1	UCC27712QDQ1
CC2340R52E0WRHBRQ1	NULL
INA296B3QDGKRQ1	NULL
TPA6304QDDVRQ1	NULL
INA296B2QDGKRQ1	NULL
AWR6843AQGABLQ1	NULL
UCC14240QDWNRQ1	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:	20250131002.2	PCN Date:	February 03, 2025
Title:	Adding KL-PR & TIEM-PR as additional wafer probe site		
Customer Contact:	Change Management team	Dept:	Quality Services
Proposed 1st Ship Date:	August 02, 2025	Estimated Sample Availability:	Samples not supported

Change Type:

☐	Assembly Site	☐	Design	☐	Wafer Bump Material
☐	Assembly Process	☐	Data Sheet	☐	Wafer Bump Process
☐	Assembly Materials	☐	Part number change	☐	Wafer Fab Site
☐	Mechanical Specification	☒	Test Site	☐	Wafer Fab Material
☐	Packing/Shipping/Labeling	☐	Test Process	☐	Wafer Fab Process

PCN Details

Description of Change:

Texas Instruments Incorporated has qualified KL-PR & TIEM-PR as additional probe site for the devices listed below to support high volume ramps.

	Current:	Additional:
Probe Site	CD-PR, CLARK-PR, DL-MOS-4	***TI Malaysia (KL-PR), TI Melaka (TIEM-PR)***

Test coverage, insertions, conditions will remain consistent with current testing.

Reason for Change:

Supply continuity.

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

Impact on Environmental Ratings:

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
☒ No Change	☒ No Change	☒ No Change	☒ No Change

Changes to product identification resulting from this PCN:

None

Product Affected:

Please refer to page 2

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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